

Thermal response of substrate structural materials during a plasma disruption *

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Intense energy fluxes to in-vessel components like the first wall and the divertor plate of a fusion reactor are expected during plasma disruptions. This high energy deposition in short times may cause severe surface erosion of these components resulting from melting and vaporization. Coatings and tile materials are proposed to protect and maintain the integrity of the underneath structural materials from both erosion losses as well as from high thermal stresses encountered during a disruption. The coating thickness should be large enough to withstand both erosion losses and to reduce the temperature rise in the substrate structural material. Yet the coating thickness should be minimized to reduce potential problems from radioactivity, toxicity, and plasma contamination. Tile materials such as graphite and coating materials such as tungsten and beryllium on structural materials like copper and steel are analyzed as potential divertor and first wall design options. The minimum coating thickness required to protect the structural material is discussed for a range of disruption parameters.

1. Introduction

High energy fluxes on the plasma chamber wall, divertor plates, and other components of a magnetic fusion reactor are expected during plasma disruptions. As a result severe surface erosion of these components is expected due to surface melting and vaporization. Coatings and tile materials are proposed as sacrificial layers to protect and maintain the integrity of the underneath structural materials. Not only coatings protect the structural materials from the severe expected erosion but also protect the structure from high thermal stresses and temperatures encountered during the disruption which can deteriorate the fatigue lifetime of these vital components.

Because of the current understanding of the severity of the disruption event and the expected total number of disruptions during the reactor lifetime, it is difficult to find a coating material with a reasonable initial thickness that can last the entire reactor lifetime. Therefore, it is proposed for a device like the International Thermonuclear Experimental Reactor (ITER), for example, to cover the first wall by a thin layer of a coating material like tungsten or beryllium. This thin layer may have to be replenished periodically by plasma spraying techniques or other methods to

maintain the integrity of the first wall. It is much easier to replace the coating material than to replace the structural material which may require extensive repair and long reactor down time.

Other design options call for the use of carbon based materials as tiles over the structural materials for protection. It is difficult however to continuously replenish the eroded carbon material from sputtering and disruption erosion by similar techniques available for metals. It is then required that the initial tile thickness be sufficient enough to protect the structure both at the beginning-of-life (BOL) and near the end-of-life (EOL) operation. The condition on the substrate is expected to be harsh near the end-of-life since the tile thickness will be eroded to its minimum and its material properties, especially the thermal conductivity, will be quite degraded by the neutron irradiation. Both reduced thickness and lower thermal conductivity of the tile tend to increase the temperature rise in the substrate during disruptions.

2. Design options and parameters

Two design options are considered in this analysis. One design option is for the first wall which uses a thin (a fraction of a millimeter) coating of tungsten or beryllium over 2 cm thick stainless steel as the structural wall material. The second design option is for the divertor plate which uses a 1 cm thick carbon-fiber-composite (CFC) as a tile material over 3 mm thick

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copper alloy as the heat sink structure. The CFC used in this analysis is the CX-2002U composite which is currently available commercially. The end-of-life analysis assumes the thickness of the CFC to be eroded down to 3 mm, with a thermal conductivity similar to that of the irradiated SEPCARB.

The disruption scenario is composed of two phases. A thermal quench phase followed by a current quench phase. The duration of the thermal quench phase is usually short and it ranges from 0.1 to 3.0 ms. The duration of the current quench phase is in the order of 10–50 ms. The energy densities deposited during the disruption considered in this analysis are typical of those for ITER design. During the thermal quench phase it is assumed that 2 MJ/m^2 is deposited on the first wall and 12 MJ/m^2 is deposited on the divertor plate. In the current quench phase, 2 MJ/M^2 is assumed deposited on both the first wall and the divertor plate.

The analysis presented in this paper is mainly devoted to studying the response of the substrate structural material to the combined two-phase disruption. The response of the tile and the coating materials to the disruptions has been analyzed in detail elsewhere [1–3]. The requirements for the coating and the tile thicknesses to maintain the thermal integrity of the substrate are investigated for various design options and disruption parameters.

3. Thermal analysis

The computer code A*THERMAL-2 [4] is used in this study to calculate the thermal response of the substrate structure during a disruption. The analysis of the first wall design case is described below. Fig. 1 shows the stainless steel substrate surface temperature for different thermal quench times followed by a 20 ms current quench disruption. The disruption energy is

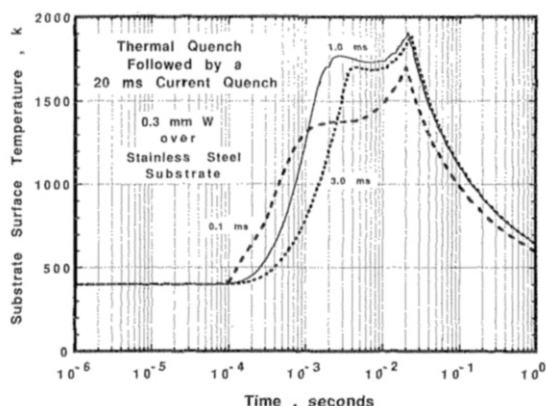


Fig. 1. The effect of the thermal disruption time on the substrate surface temperature.

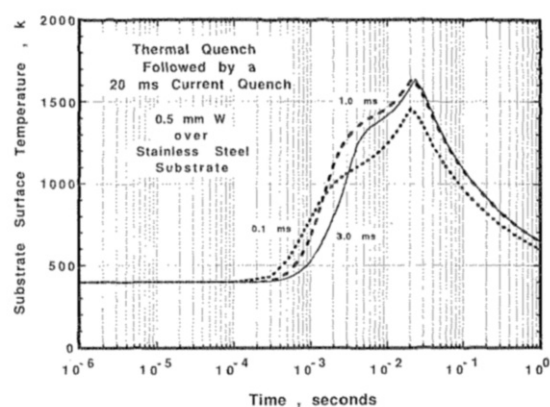


Fig. 2. Stainless steel substrate surface temperature for 0.5 mm tungsten coating.

assumed to be 2 MJ/m^2 for both the thermal and the current disruption phases. The coating material is tungsten with a thickness of 0.3 mm. It is interesting to note that the lowest substrate surface temperature results from the shortest thermal quench time, i.e., 0.1 ms, and the highest surface temperature is due to the 1.0 ms thermal quench contrary to the response of the tile or the coating material [1]. This can be explained as the following. Shorter disruption time usually results in the highest surface temperature of the coating or the tile material that is directly exposed to the disruption. This means more erosion of the coating or the tile material. Consequently a larger fraction of the incident energy is spent in vaporizing the surface material, leaving a lower fraction of the energy to be conducted through the tile to the substrate material, which causes lower temperature rise. Longer disruption times, however, result in lower temperatures throughout the tile and the substrate materials. It can also be seen from fig. 1 that the stainless steel surface temperature will exceed its melting point (1700 K) for the cases of 1.0 and 3.0 ms thermal disruption time. This means the 0.3 mm tungsten coating thickness is not sufficient to protect the substrate structure. In addition to the resulting high thermal stresses, repeated melting and solidification of the interface between the coating and the substrate may develop cracks and gaps which tend to drive the temperature even higher.

Fig. 2 shows the substrate surface temperature for the same conditions as for fig. 1 but for a tungsten coating of 0.5 mm thickness. No melting of the steel substrate is predicted in this case for any of the thermal disruption times considered. In general thicker coating materials offer better protection to the substrate structural material. The effect of different current disruption times on the substrate surface temperature after 1.0 ms thermal quench is shown in fig. 3. Shorter current quench deposition time will probably result in higher substrate temperature as opposed to

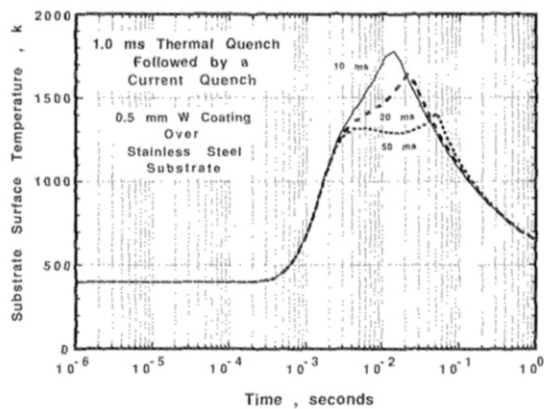


Fig. 3. The effect of the current disruption time on the substrate surface temperature.

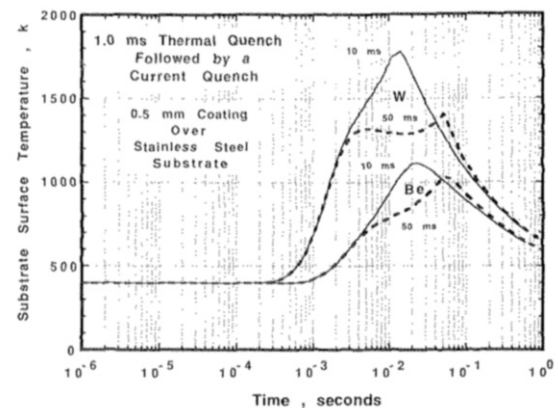


Fig. 5. The effect of different coating materials on the substrate surface temperature.

the shorter thermal quench time. This is true mainly because the current quench time is usually much longer than the thermal quench time. Longer disruption times allow less energy to go toward eroding the coating or the tile material and more energy in conduction through the substrate material.

The current quench effect on the substrate material is usually tolerable for disruption energies around 2 MJ/m². It is, however, when the current quench disruption immediately follow the thermal quench phase and occur on the same disruption location that will cause much higher substrate surface temperatures. Fig. 4 shows the response of the substrate to a separate thermal and a separate current quench as well as to a combined thermal and current disruption. For locations where the two disruptions do not overlap, the substrate temperature does not exceed the melting temperature even for a 0.3 mm thick tungsten coating.

The effect of using beryllium coating vs tungsten coating of the same thickness over stainless steel substrate is shown in fig. 5. Beryllium coating substantially

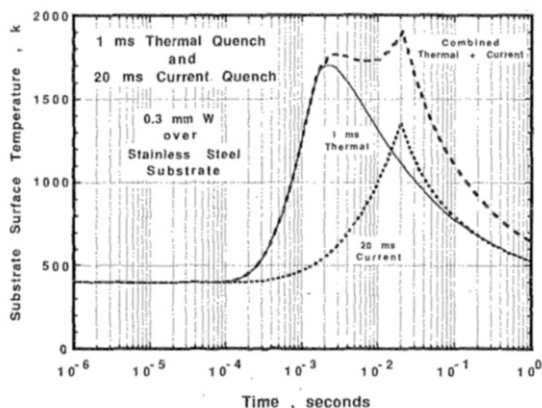


Fig. 4. Response of the substrate to a separate and to a combined disruptions.

reduces the substrate temperature rise during the disruption compared to the tungsten coating. Thus the beryllium coating offers a better protection to the substrate for the same coating thickness and disruption parameters. The main reason is that beryllium is less resistant to the disruption than tungsten. This means that more disruption energy will be spent in eroding beryllium than tungsten, leaving less energy to be conducted through the substrate. The better protection to the substrate is then at the expense of higher beryllium erosion than tungsten. These disruption conditions happen to be less than the threshold required for any significant tungsten vaporization. Recoating by plasma spraying or other techniques will then be more frequently required in the case of beryllium. In addition, the cost of cleaning the redeposited material after disruptions, safety considerations, and potential plasma contamination may be higher for the beryllium case.

The analysis for the divertor design option, where a CFC tile is used on a 3 mm copper substrate, is described below. It is expected that the most severe conditions on the copper substrate will be near the end-of-life, where the tile thickness is eroded to its minimum and has suffered extensive radiation damage to its properties. The response of the tile material to a two-phase disruption scenario is shown in fig. 6. Shorter thermal disruption times will always result in the highest tile surface temperature rise and usually the highest erosion rate. There are two factors that affect the response of the tile at BOL and at EOL to a disruption. The first factor is that at BOL where the tile initial thickness is much larger, the tile surface temperature prior to a disruption is higher. This tends to increase the tile erosion rate at BOL. The second factor is that at EOL the tile thermal conductivity is lower because of the irradiation damage. This slightly tends to increase the erosion rate at EOL. The overall tile erosion rate at BOL and EOL is somewhat similar for the same disruption conditions.

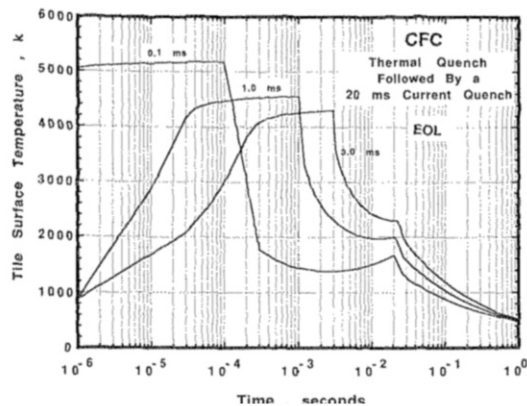


Fig. 6. Tile surface temperature rise for a two-phase disruption scenario.

The copper substrate surface temperature rise at EOL for different thermal quench times is shown in fig. 7. The shorter the thermal quench, the lower the copper surface temperature. The maximum copper surface temperature is less than 900 K for a duration of less than 1 s as a result of these disruption parameters. However, smaller tile thicknesses than 3 mm and higher disruption energies will result in an unacceptable higher substrate temperature and may cause irreversible damage to the structure.

Fig. 8 compares the substrate surface temperature at BOL and at EOL. It can be seen that at BOL the temperature rise is much lower and occurs later in time than that at EOL. It is then important when designing a system like this to take into consideration all the expected conditions near the end-of-life. This should include the allowed minimum tile thickness, its degraded conductivity, the disruption scenario, and the deposited energy densities.

There are other important factors that may affect the performance of both the coating/tile materials and

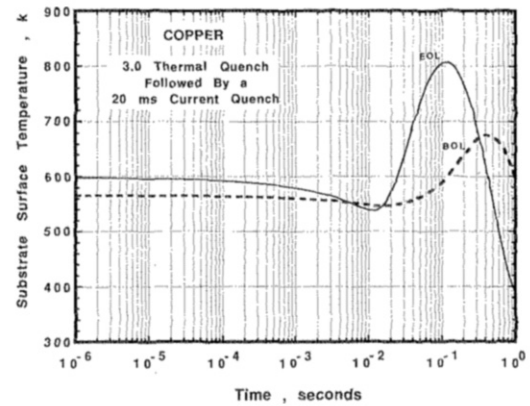


Fig. 8. Substrate surface temperature at both the beginning and at the end-of-life.

the substrate structural materials. One important factor is the vapor shielding effect i.e., the shielding of the surface material by its own vapor against the plasma particles [5]. Vapor shielding may protect both the surface and the substrate materials by reducing the amount of energy that reaches the surface material during a disruption. A second important factor is the stability of the melt layer developed at the surface of a metallic coating during a disruption [6]. Erosion due to a melt layer runoff or due to instabilities will cause substantial damage to both the coating and the substrate materials. Melt layer runoff and loss due to growing instabilities are particularly important at longer deposition times, specifically during the current quench phases [7]. Another important factor is the condition of the plasma sprayed metallic material needed to replenish the eroded material. Porous sprayed coating material with lower thermal conductivity is found to protect the substrate structure better than the full dense coating material [8].

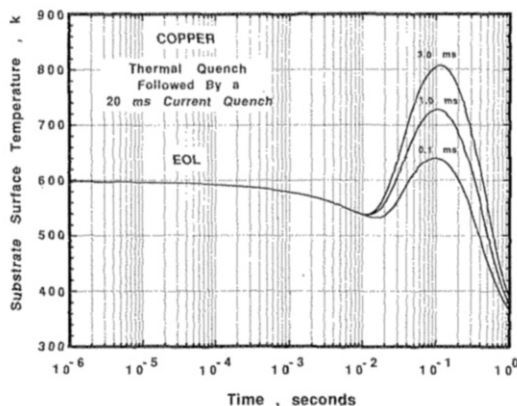


Fig. 7. The effect of the thermal quench time on the substrate surface temperature.

4. Conclusions

Thermal analysis of the substrate structural materials is analyzed in detail during plasma disruptions. Tile and coating materials are essential to protect the substrate structure materials during the disruption. The disruption scenario and parameters are key factors in determining the required minimum thickness of coating and tile materials to protect the structure underneath. Beryllium coating, in general, protects the substrate material better than tungsten for the same disruption conditions. Adequate substrate performance for a tile design should be evaluated near the end-of-life of the tile material. Coating thickness should be minimized to reduce potential problems such as radioactivity, toxicity, and plasma contamination.

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